1. General description

Ultra-low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a DFN1006BD-2 (SOD882BD) leadless ultra small Surface-Mounted Device (SMD) plastic package, designed to protect one signal line from the damage caused by ESD and other transients.

2. Features and benefits

- Ultra low diode capacitance $C_d = 0.34 \, \text{pF}$
- High reverse standoff voltage $V_{RWM} = 30 \, \text{V}$
- Very small voltage dependency of the capacitance
- ESD protection up to $\pm 15 \, \text{kV}$ according to IEC 61000-4-2, level 4
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- NFC and antenna protection
- Protection of high-speed data lines

4. Quick reference data

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_{RWM}$</td>
<td>reverse standoff voltage</td>
<td>$T_{\text{amb}} = 25 , \text{°C}$</td>
<td>-</td>
<td>-</td>
<td>30</td>
<td>V</td>
</tr>
<tr>
<td>$C_d$</td>
<td>diode capacitance</td>
<td>$f = 1 , \text{MHz}; , V_R = 0 , \text{V}; , T_{\text{amb}} = 25 , \text{°C}$</td>
<td>-</td>
<td>0.34</td>
<td>0.43</td>
<td>pF</td>
</tr>
</tbody>
</table>
5. Pinning information

Table 2. Pinning information

<table>
<thead>
<tr>
<th>Pin</th>
<th>Symbol</th>
<th>Description</th>
<th>Simplified outline</th>
<th>Graphic symbol</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>K1</td>
<td>cathode (diode 1)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>2</td>
<td>K2</td>
<td>cathode (diode 2)</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

6. Ordering information

Table 3. Ordering information

<table>
<thead>
<tr>
<th>Type number</th>
<th>Package</th>
<th>Description</th>
<th>Version</th>
</tr>
</thead>
<tbody>
<tr>
<td>PESD30VF1BALS-Q</td>
<td>DFN1006BD-2</td>
<td>Leadless ultra small plastic package with side-wettable flanks (SWF); 2 terminals; 0.65 mm pitch; 1 mm x 0.6 mm x 0.47 mm body</td>
<td>SOD882BD</td>
</tr>
</tbody>
</table>

7. Marking

Table 4. Marking codes

<table>
<thead>
<tr>
<th>Type number</th>
<th>Marking code</th>
</tr>
</thead>
<tbody>
<tr>
<td>PESD30VF1BALS-Q</td>
<td>N+N</td>
</tr>
</tbody>
</table>
8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>T_j</td>
<td>junction temperature</td>
<td></td>
<td>-</td>
<td>150</td>
<td>°C</td>
</tr>
<tr>
<td>T_amb</td>
<td>ambient temperature</td>
<td></td>
<td>-65</td>
<td>150</td>
<td>°C</td>
</tr>
<tr>
<td>T_stg</td>
<td>storage temperature</td>
<td></td>
<td>-65</td>
<td>150</td>
<td>°C</td>
</tr>
</tbody>
</table>

ESD maximum ratings

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>V_ESD</td>
<td>electrostatic discharge</td>
<td>IEC 61000-4-2; contact discharge</td>
<td>1</td>
<td>15</td>
<td>kV</td>
</tr>
<tr>
<td></td>
<td>voltage</td>
<td>IEC 61000-4-2; air discharge</td>
<td>1</td>
<td>15</td>
<td>kV</td>
</tr>
</tbody>
</table>


Fig. 1. ESD pulse waveform according to IEC 61000-4-2

Fig. 2. V-I characteristics for a bidirectional ESD protection diode
9. Characteristics

Table 6. Characteristics

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$V_{RWM}$</td>
<td>reverse standoff voltage</td>
<td>$T_{amb} = 25 , ^\circ C$</td>
<td>-</td>
<td>-</td>
<td>30</td>
<td>V</td>
</tr>
<tr>
<td>$V_{BR}$</td>
<td>breakdown voltage</td>
<td>$I_R = 10 , mA; \ T_{amb} = 25 , ^\circ C$</td>
<td>31</td>
<td>35</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td>$I_{RM}$</td>
<td>reverse leakage current</td>
<td>$V_R = 30 , V; \ T_{amb} = 25 , ^\circ C$</td>
<td>-</td>
<td>1</td>
<td>30</td>
<td>nA</td>
</tr>
<tr>
<td>$C_d$</td>
<td>diode capacitance</td>
<td>$f = 1 , MHz; \ V_R = 0 , V; \ T_{amb} = 25 , ^\circ C$</td>
<td>-</td>
<td>0.34</td>
<td>0.43</td>
<td>pF</td>
</tr>
<tr>
<td>$V_{CL}$</td>
<td>clamping voltage</td>
<td>$I_{TLP} = 8 , A; \ t_p = 100 , ns; \ T_{amb} = 25 , ^\circ C$</td>
<td>[1]</td>
<td>-</td>
<td>18</td>
<td>-</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$I_{TLP} = 16 , A; \ t_p = 100 , ns; \ T_{amb} = 25 , ^\circ C$</td>
<td>[1]</td>
<td>-</td>
<td>21</td>
<td>-</td>
</tr>
<tr>
<td>$R_{dyn}$</td>
<td>dynamic resistance</td>
<td>$I_R = 10 , A; \ t_p = 100 , ns; \ T_{amb} = 25 , ^\circ C$</td>
<td>[1]</td>
<td>-</td>
<td>0.6</td>
<td>-</td>
</tr>
</tbody>
</table>

[1] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.5.1-2008.

Fig. 3. Insertion loss; typical values

Fig. 4. Diode capacitance as a function of reverse voltage; typical values
Fig. 5. Dynamic resistance with positive clamping; typical values

Fig. 6. Dynamic resistance with negative clamping; typical values

Fig. 7. Dynamic resistance with positive clamping; typical values

Fig. 8. Dynamic resistance with negative clamping; typical values
10. Application information

The device is designed for the protection of one bidirectional data line from surge pulses and ESD damage. The device is suitable on lines where the signal polarities are both positive and negative with respect to ground.

The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

![Application diagram](image)

**Fig. 9. Application diagram**

**Circuit board layout and protection device placement**

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the device as close to the input terminal or connector as possible.
2. Minimize the path length between the device and the protected line.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.

11. Test information

**Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.
12. Package outline

DFN1006BD-2  Leadless ultra small plastic package with side-wettable flanks (SWF); 2 terminals; 0.65 mm pitch; 1 mm x 0.6 mm x 0.47 mm body

Note
1. Dimension including plating thickness.
2. The marking bar indicates the cathode.
3. Solderable lead end, protrusion max. 0.02 mm.

Fig. 10. Package outline DFN1006BD-2 (SOD882BD)
13. Soldering

Fig. 11. Reflow soldering footprint for DFN1006BD-2 (SOD882BD)
# 14. Revision history

<table>
<thead>
<tr>
<th>Data sheet ID</th>
<th>Release date</th>
<th>Data sheet status</th>
<th>Change notice</th>
<th>Supersedes</th>
</tr>
</thead>
<tbody>
<tr>
<td>PESD30VF1BALS-Q v.1</td>
<td>20240118</td>
<td>Product data sheet</td>
<td>-</td>
<td>-</td>
</tr>
</tbody>
</table>

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15. Legal information

Data sheet status

<table>
<thead>
<tr>
<th>Document status</th>
<th>Product status</th>
<th>Definition</th>
</tr>
</thead>
<tbody>
<tr>
<td>Preliminary</td>
<td>Development</td>
<td>This document contains data from the objective specification for product development.</td>
</tr>
<tr>
<td>Short data sheet</td>
<td>Qualification</td>
<td>This document contains data from the preliminary specification.</td>
</tr>
<tr>
<td>Product data sheet</td>
<td>Production</td>
<td>This document contains the product specification.</td>
</tr>
</tbody>
</table>

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term "short data sheet" is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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Ultra-low capacitance bidirectional ESD protection diode

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